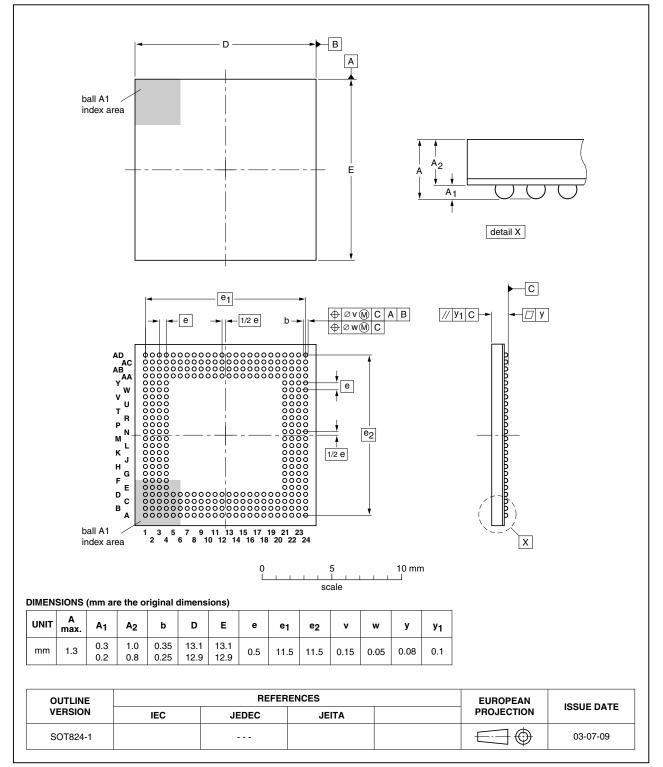


Package outline



LFBGA320: plastic low profile fine-pitch ball grid array package; 320 balls; body 13 x 13 x 0.9 mm SOT824-1

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